

Title (en)
EPOXY RESIN COMPOSITIONS FOR USE IN ELECTRICAL LAMINATES

Publication
EP 0507271 A3 19930421 (EN)

Application
EP 92105603 A 19920401

Priority
• JP 9614691 A 19910403
• JP 18836191 A 19910703

Abstract (en)
[origin: EP0507271A2] Electrical laminates can be prepared from an epoxy resin composition which comprises: (A) at least one epoxy resin having an average of more than one epoxy group per molecule; (B) an oligomer having a terminal phenolic hydroxyl group, which oligomer results from the reaction of a glycidyl ether of a halogenated phenolic compound and a halogenated phenolic compound; and (C) at least one catalyst for catalyzing a reaction between Component (A) and Component (B). <IMAGE>

IPC 1-7
C08L 63/00; **C08G 59/18**; **H01B 3/40**

IPC 8 full level
C08G 59/18 (2006.01); **C08G 59/24** (2006.01); **C08G 59/32** (2006.01); **C08G 59/38** (2006.01); **H01B 3/40** (2006.01); **H05K 1/03** (2006.01)

CPC (source: EP KR US)
C08G 59/182 (2013.01 - EP US); **C08G 59/245** (2013.01 - EP US); **C08G 59/3218** (2013.01 - EP US); **C08G 59/3227** (2013.01 - EP US); **C08G 59/38** (2013.01 - EP US); **C08L 63/00** (2013.01 - KR); **H01B 3/40** (2013.01 - EP US); **H05K 1/0326** (2013.01 - EP US)

Citation (search report)
• [A] EP 0119164 A1 19840919 - VERNICOLOR LACK FARBEN [CH]
• [A] US 4322456 A 19820330 - MARTIN PATRICK H
• [A] WO 8702043 A1 19870409 - DOW CHEMICAL CO [US]

Cited by
CN103819655A; SG85624A1; EP0943639A3; US6255409B1; US8980376B2; US10074803B2; US10476005B2

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